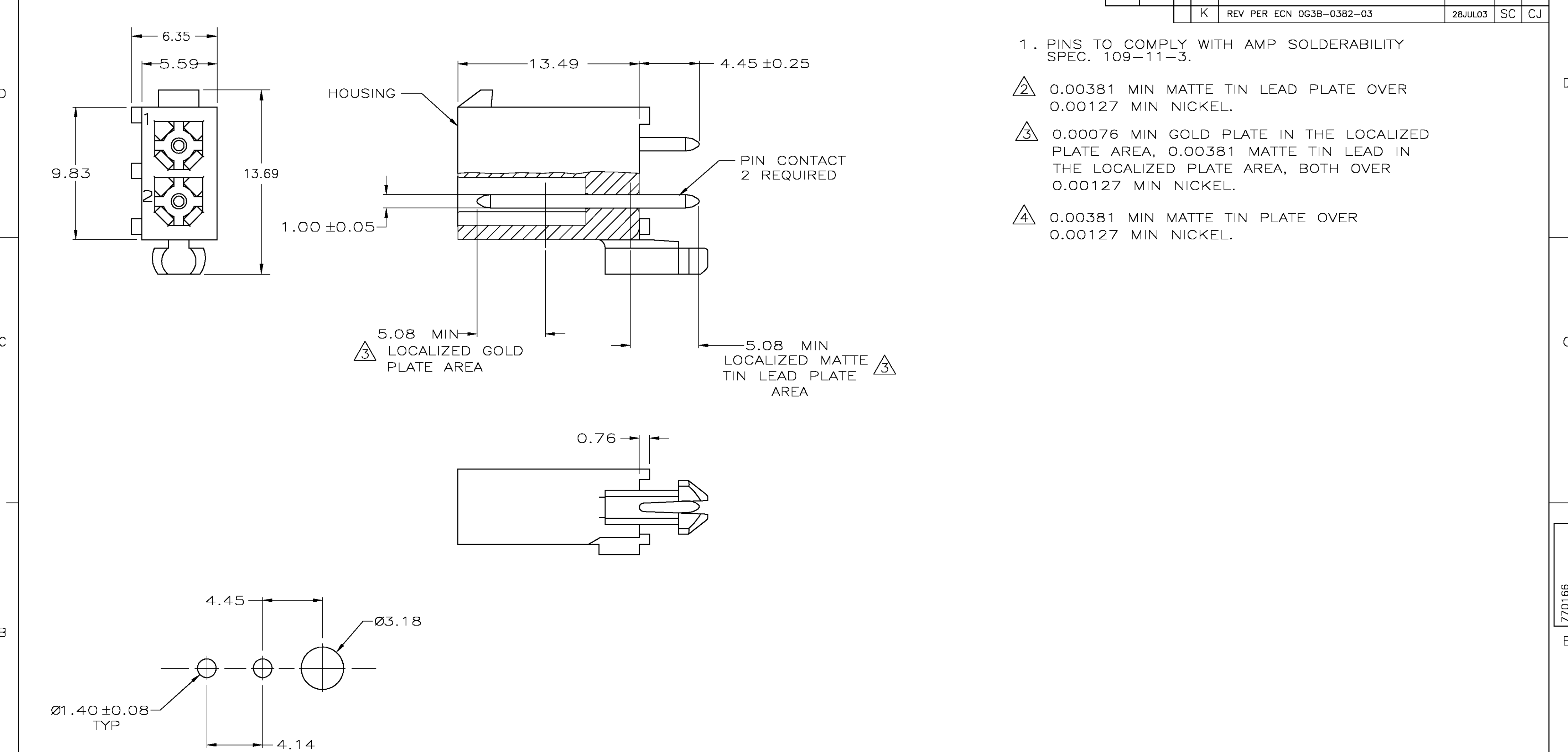




1. PINS TO COMPLY WITH AMP SOLDERABILITY SPEC. 109-11-3.
2. 0.00381 MIN MATTE TIN LEAD PLATE OVER 0.00127 MIN NICKEL.
3. 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN LEAD IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.
4. 0.00381 MIN MATTE TIN PLATE OVER 0.00127 MIN NICKEL.

RECOMMENDED LAYOUT FOR 1.57 THICK BOARD
TOLERANCES NON-ACCUMULATIVE

1.00	.039	13.49	.531
0.76	.030	9.83	.387
0.25	.010	5.59	.220
0.13	.005	5.08	.200
0.08	.003	4.45	.175
0.05	.002	4.14	.163
0.00381	0.000150	3.18	.125
0.00127	0.000050	1.57	.062
0.00076	0.000030	1.40	.055
MM	IN	MM	IN

METRIC

THIS DRAWING IS A CONTROLLED DOCUMENT.	DWN S. CARPENTER 28JUL2003	Tyco Electronics Corporation Harrisburg, PA 17105		
DIMENSIONS: INCHES	CHK C. JONES 28JUL2003	NAME HEADER ASSEMBLY, 2 CKT, MINI-UNIVERSAL MATE-N-LOK™		
	TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ± 1 PLC ± 2 PLC ± 0.13 3 PLC ± 4 PLC ± ANGLES ± FINISH	APVD C. JONES 28JUL2003	PRODUCT SPEC	APPLICATION SPEC
MATERIAL SEE TABLE	WEIGHT	SIZE A2	CAGE CODE 00779	DRAWING NO 770166
CUSTOMER DRAWING		SCALE 5:1	SHEET 1 OF 1	REV K